Lighting Color

• Amber

# LNJ424C46RA

### Hight Bright Surface Mounting Chip LED

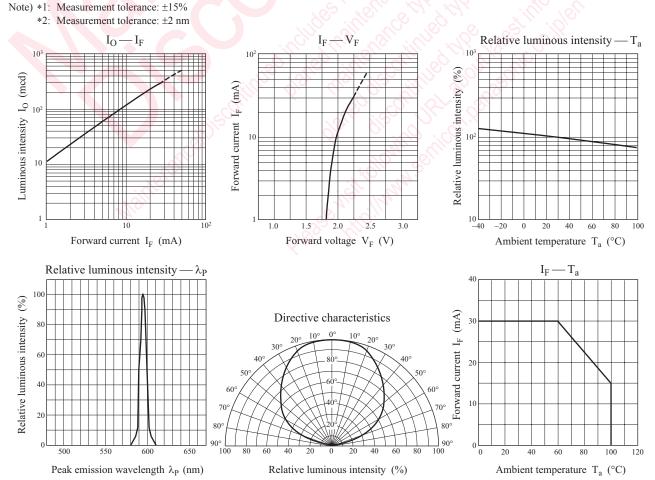
#### 3528 (PLCC2) Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Power dissipation	P <sub>D</sub>	80	mW
Forward current	$I_{\rm F}$	30	mA
Pulse forward current *	I <sub>FP</sub>	90	mA
Reverse voltage	V <sub>R</sub>	4	V
Operating ambient temperature	T <sub>opr</sub>	-40 to +100	°C
Storage temperature	T <sub>stg</sub>	-40 to +100	°C

#### Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

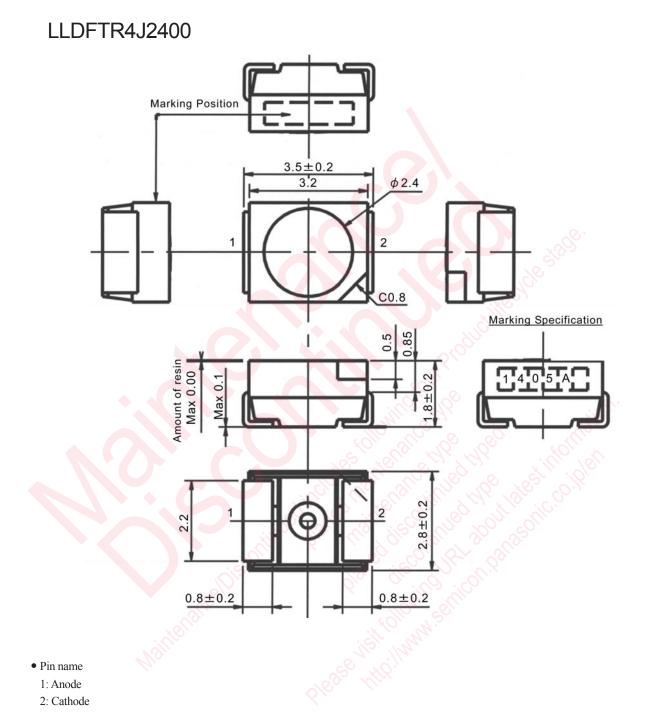
T <sub>opr</sub>	-40 to $+100$	°C							
T <sub>stg</sub>	-40 to +100	°C							
width 1 mse	ec.								
Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$									
Symbol		Conditions	Min	Тур	Max	Unit			
Io	$I_F = 20 \text{ mA}$	, NN	<sup>ک</sup> 140	230	380	mcd			
I <sub>R</sub>	$V_R = 4 V$	0,00			100	μΑ			
V <sub>F</sub>	$I_F = 20 \text{ mA}$			2.1	2.5	V			
$\lambda_{\rm P}$	$I_F = 20 \text{ mA}$			595	~	nm			
$\lambda_d$	$I_F = 20 \text{ mA}$	Millio tak	584	589	596	nm			
Δλ	$I_F = 20 \text{ mA}$	Mon Room	SO .	20	<u>(</u> 0	nm			
	$T_{stg}$ width 1 mse $= 25^{\circ}C \pm 3^{\circ}O$ Symbol I <sub>O</sub> I <sub>R</sub> V <sub>F</sub> $\lambda_P$ $\lambda_d$	$T_{stg}$ -40 to +100         width 1 msec.         = 25°C±3°C         Symbol         I <sub>O</sub> I <sub>F</sub> = 20 mA         I <sub>R</sub> V <sub>R</sub> = 4 V         V <sub>F</sub> I <sub>F</sub> = 20 mA $\lambda_P$ I <sub>F</sub> = 20 mA $\lambda_d$ I <sub>F</sub> = 20 mA	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{tabular}{ c c c c c c c } \hline T_{stg} & -40 \ to +100 & ^{\circ}C \\ \hline \end{tabular} \\ \hline width 1 \ msec. \\ \hline = 25^{\circ}C \pm 3^{\circ}C \\ \hline \hline \\ \hline Symbol & Conditions & Min \\ \hline I_O & I_F = 20 \ mA & 140 \\ \hline I_R & V_R = 4 \ V & 140 \\ \hline I_R & V_R = 4 \ V & 140 \\ \hline V_F & I_F = 20 \ mA & 140 \\ \hline \lambda_P & I_F = 20 \ mA & 140 \\ \hline \lambda_d & I_F = 20 \ mA & 584 \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$			



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#### LNJ424C46RA

Package (Unit: mm)



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